DECLARATION and POWER OF ATTORNEY

		and POWER OF	ALIORNET			
			☑ ORIGINAL☐ CONTINUATION☐ DIVISIONAL			
or an or	iginal, first and joint inventor (if	nat the information given herein is true, that I believ plural names are listed below) of the subject matte BONDING APPARATUS A		d sole inventor (n a patent is sou	if only one name is listed a ght on the invention entitle	is 1 below) ed:
the spe	cification of which is attached he was filed on	ereto unless the following box is checked:as United States Application Number or PC	T International Application Num	ber		
	and was amended on	•				
l acknow I hereby	Medge my duty to disclose infor state that I have reviewed and	citizenship are as stated below next to my name. mation which is material to the patentability of this understand the contents of the above identified sp under Title 35, United States Code, § 119 of any fo for patent or inventor's certificate having a filing da	reion application(s) for patent o	r inventor's cert	ficate listed below and have	
dentine	a bolott ally foreign application	PRIOR FOREIGN				
	COUNTRY	APPLICATION NUMBER	DATE OF F!LING Month Day Year		PRIORITY CLAIMED 35 U.S.C. 119	
	Japan	2000-290071	September 25, 20	00	Yes	
below a	nd, insofar as the subject matte	C. 120 of any United States application(s), or 365(er of each of the claims of this application is not dis .S.C. 112, I acknowledge the duty to disclose infor prior application and the national or PCT internation	mation which is material to pate	entability as defir		
64m - 11 -	r O-i-(N-)	(Filing	Date)			(Status)
POWE Traden	ark Office connected therewith.	f Inventor, I hereby appoint the following registered		s application and	d transact all business in ti	ne Patent and
Send	correspondence to:	KODA & ANDROLIA 2029 Century Park East. Suite 3850 Los Angeles, CA 90067-3024	DIRECT TELEPHONE CALL		A & ANDROLIA 77-1391	
rease			Residence: CITY		STATE or COUNTRY	
- 18 A	Name of Inventor KENJI SUGAWARA		KOKUBUNJI		Japan	
1	Post Office Address					CITIZENSHIP
	1-13-51, Naito, Kokubunji				Japan	
<u> </u>		rstil, Tokyo, sapari	Residence: CITY		STATE or COUNTRY	
72	Name of Inventor		Residence. Dir:			
IJ	Post Office Address		-		,	CITIZENSHIP
*	Name of Inventor		Residence: CITY		STATE or COUNTRY	
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4	Post Office Address					CITIZENSHIP
these s	tatements were made with the	ade herein of my own knowledge are true and that knowledge that willful false statements and the like leopardize the validity of the application or any pate	so made are punishable by ith	ation and belief a e or imprisonme	are believed to be true; and ent, or both, under 18 U.S.	d further that C. 1001 and
SIGNATURE OF INVENTOR 1			SIGNATURE OF INVENTOR 2			
DATE 9/19/200/			DATE			
SIGNATURE OF INVENTOR 3			SIGNATURE OF INVENTOR 4			

DATE

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I hereby certify that this correspondence is being deposited with the United States Postal Service as Express Mail No. EL919844975US addressed to:

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on September 25, 2001 by Inja Yi.

Dated: 9/25/0/

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SHINKAWA

Inventor(s):

KENJI SUGAWARA

For:

BONDING APPARATUS AND BONDING METHOD